

## IKWH70N65WR6-VB Datasheet

### 600V Trench and Fieldstop IGBT



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**

PRODUCT SUMMARY		
$V_{CE}$ (V)	600	
$I_C$ (A)	90 ( $T_C=25$ )	75 ( $T_C=100$ )
$V_{CE(sat)}$ (V)	1.7	
$Q_g$ (nC)	175	
$I_{CM}$ (A)	225	

#### FEATURES

- Very Low  $V_{CEsat}$
- Low turn-off losses
- High speed switching
- Maximum junction temperature 175°C
- Ultra low gate charge ( $Q_g$ )
- Avalanche energy rated (UIS)

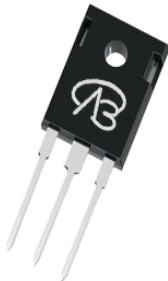
#### APPLICATIONS

- Telecommunications
  - Server and telecom power supplies
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Consumer and computing
  - ATX power supplies
- Industrial
  - Welding
  - Battery chargers
- Renewable energy
  - Solar (PV inverters)
- Switch mode power supplies (SMPS)

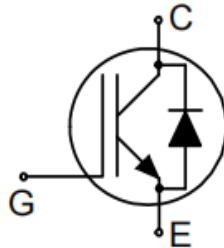
#### Package pin definition

- Pin1 G - Gate
- Pin2 C & backside - Collector
- Pin3 E - Emitter

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Top View



ABSOLUTE MAXIMUM RATINGS ( $T_C = 25$ °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Collector-Emitter Voltage	$V_{CE}$	600	V		
Gate-Emitter Voltage	$V_{GE}$	$\pm 30$			
Continuous Collector Current ( $T_J = 150$ °C)	$V_{GE}$ at 15 V	$T_C = 25$ °C	150	A	
		$T_C = 100$ °C	75		
Pulsed Collector Current <sup>a</sup>		$I_{CM}$	225		
Diode Forward Current <sup>b</sup>		$I_F$	90	A	
Maximum Power Dissipation		$T_C = 25$ °C	400	W	
		$T_C = 100$ °C	220	W	
Operating Junction and Storage Temperature Range		$T_J, T_{stg}$	-55 to +175	°C	
Short Circuit Withstand Time $T_C=150$	$V_{GE}= 15V, V_{CE} 400V$	tsc	3	$\mu s$	
Short Circuit Withstand Time $T_C=100$			$V_{GE}= 15V, V_{CE} 330V$		5
Soldering Recommendations (Peak Temperature) <sup>c</sup>			for 10 s	260	°C

#### Notes

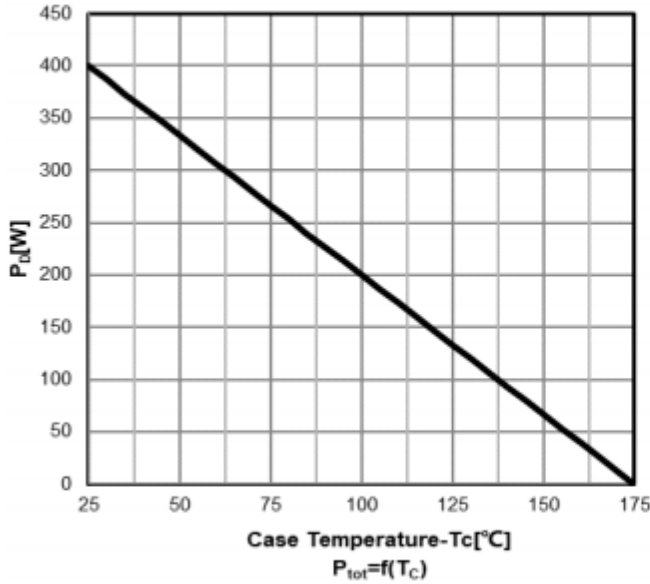
- Repetitive rating; pulse width limited by maximum junction temperature.
- Current limited by maximum junction temperature.
- 1.6 mm from case.

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	$R_{thJA}$	-	40	°C/W
Maximum Junction-to-Case	$R_{thJC}$	-	0.5	

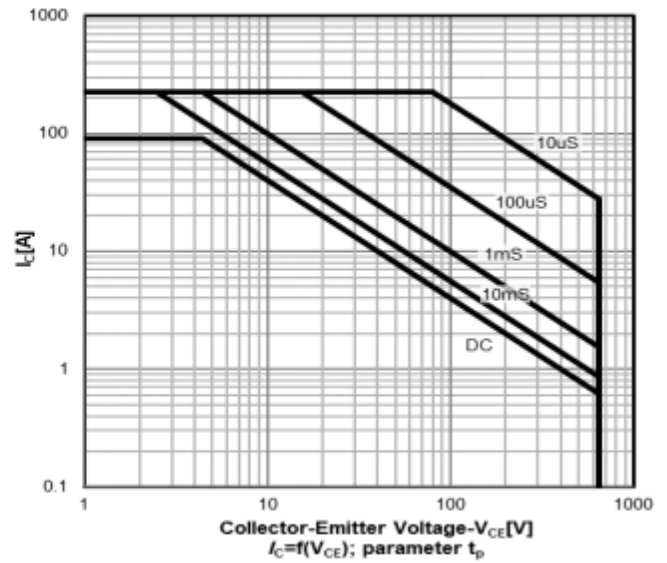
SPECIFICATIONS ( $T_J = 25\text{ }^\circ\text{C}$ , unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
<b>Static</b>							
Collector-Emitter Breakdown Voltage	$BV_{CE}$	$V_{GE} = 0\text{ V}, I_C = 250\text{ }\mu\text{A}$ $V_{GE} = 0\text{ V}, I_C = 1\text{ mA}$		600 600	- -	- -	V
Gate-Source Threshold Voltage (N)	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_D = 250\text{ }\mu\text{A}$		4	5	6	V
Zero Gate Voltage Collector Current	$I_{CES}$	$V_{CE} = 480\text{ V}, V_{GE} = 0\text{ V}, T_J = 25\text{ }^\circ\text{C}$		-	1	20	$\mu\text{A}$
		$V_{CE} = 480\text{ V}, V_{GE} = 0\text{ V}, T_J = 150\text{ }^\circ\text{C}$		-	1000	-	$\mu\text{A}$
Gate-Emitter Leakage Current	$I_{GES}$	$V_{CE} = 0\text{ V}, V_{GS} = \pm 2.0\text{ V}$		-	-	100	nA
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15\text{ V}$	$I_C = 75\text{ A}$	-	1.7	2.1	V
Forward Transconductance	$g_{fs}$	$V_{CE} = 20\text{ V}, I_C = 75\text{ A}$		-	40	-	S
<b>Dynamic</b>							
Input Capacitance	$C_{ies}$	$V_{GE} = 0\text{ V}, V_{CE} = 25\text{ V},$ $f = 500\text{ KHz}$		-	4600	-	pF
Output Capacitance	$C_{oes}$			-	235	-	
Reverse Transfer Capacitance	$C_{res}$			-	72	-	
Turn-on Energy	$E_{on}$	$V_{CE} = 400\text{ V}, V_{GE} = 0/15\text{V},$ $I_C = 75\text{ A}, R_g = 10\Omega$		-	0.62	-	ns
Turn-off Energy	$E_{off}$			-	0.31	-	
Total Gate Charge	$Q_g$	$V_{GE} = 15\text{ V}$	$I_C = 75\text{ A}, V_{CE} = 400\text{ V}$	-	175	-	nC
Gate-Emitter Charge	$Q_{ge}$			-	14	-	
Gate to Collector Charge	$Q_{gc}$			-	33	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{CE} = 400\text{ V}, V_{GE} = 0/15\text{V},$ $I_C = 75\text{ A}, R_g = 10\Omega$		-	60	-	ns
Rise Time	$t_r$			-	43	-	
Turn-Off Delay Time	$t_{d(off)}$			-	184	-	
Fall Time	$t_f$			-	30	-	
Internal emitter inductance measured 5 mm	$L_E$			-	13	-	
<b>Diode Characteristics</b>							
Diode Forward Current	$I_F$	IGBT symbol showing the integral reverse junction diode		-	-	75	A
Pulsed Diode Forward Current	$I_{FM}$			-	-	225	
Diode Forward Voltage	$V_F$	$I_F = 30\text{ A}$		-	1.65	2.0	V
Reverse Recovery Time	$t_{rr}$	$T_J = 25\text{ }^\circ\text{C}, I_F = 30\text{ A},$ $dI_F/dt = 200\text{ A}/\mu\text{s}, V_R = 400\text{ V}$		-	73	-	ns
Reverse Recovery Charge	$Q_{rr}$			-	85	-	$\mu\text{C}$
Reverse Recovery Current	$I_{RRM}$			-	13	-	A

**TYPICAL CHARACTERISTICS** (25 °C, unless otherwise noted)

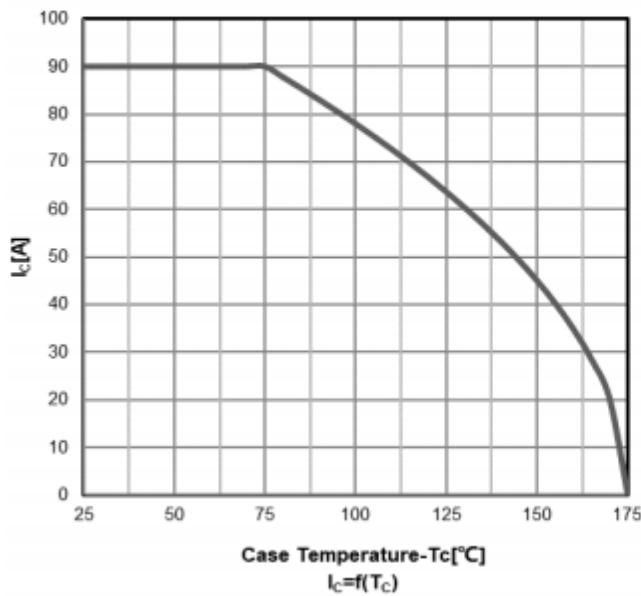
Power dissipation



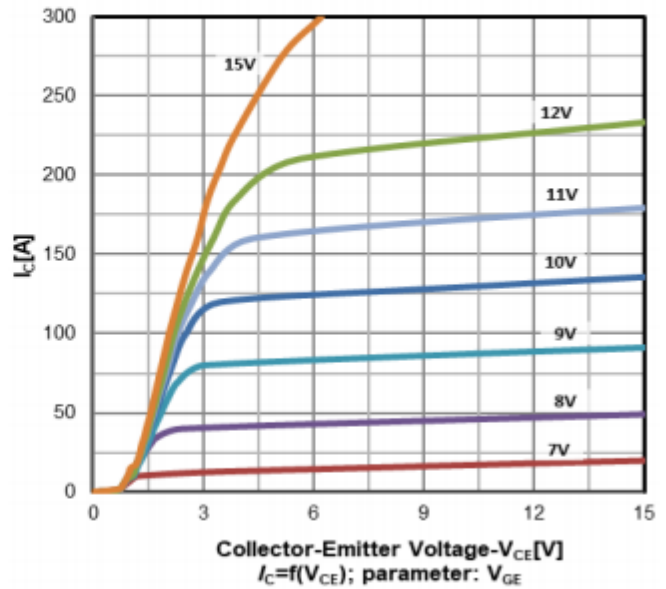
Safe operating area  $T_a=25\text{ }^\circ\text{C}$



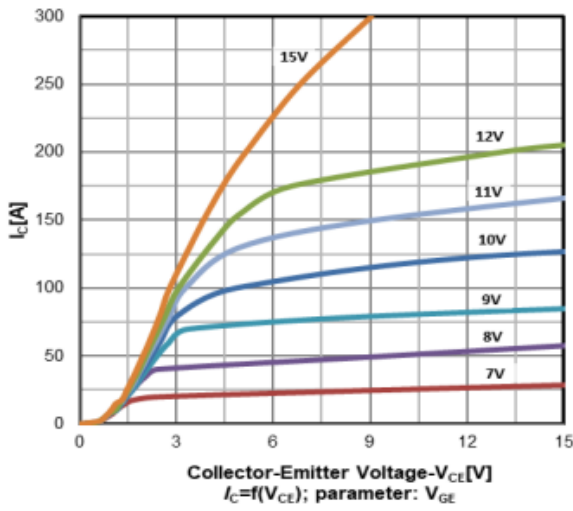
Collector current as a function of Case temperature



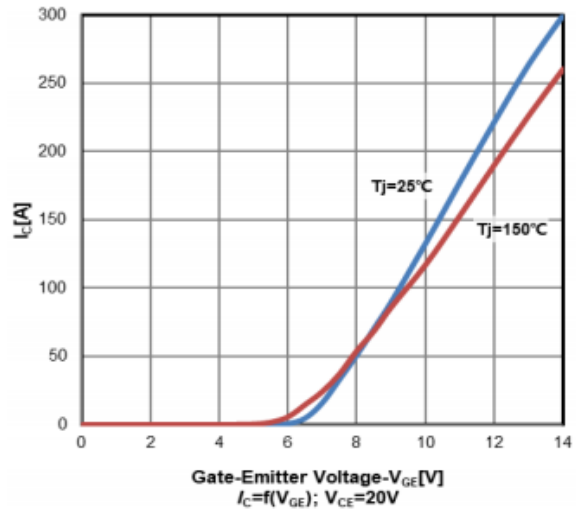
Typ. Output characteristics  $T_j=25\text{ }^\circ\text{C}$



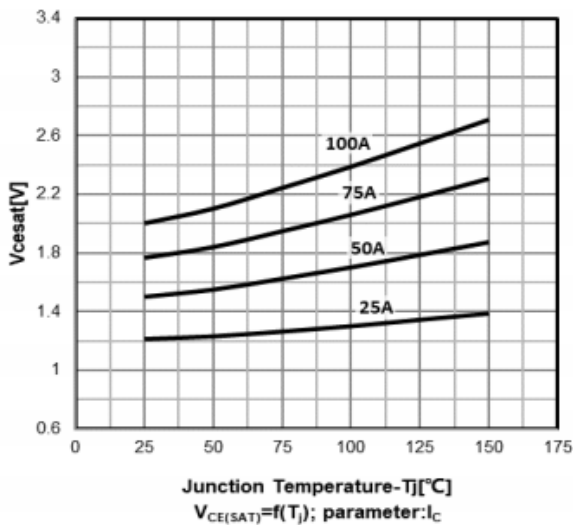
Typ. Output characteristics  
 $T_j=150\text{ }^\circ\text{C}$



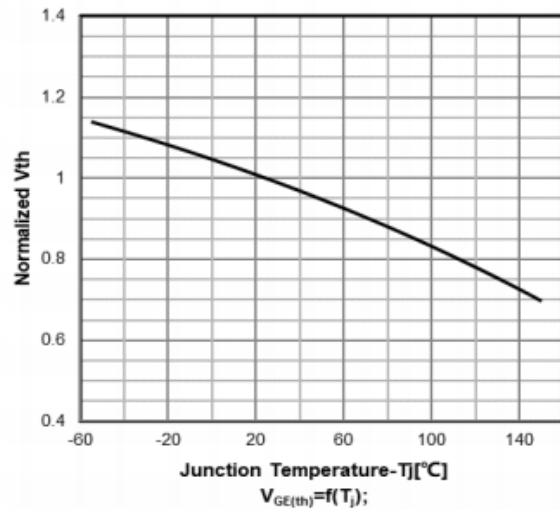
Typ. Transfer characteristics



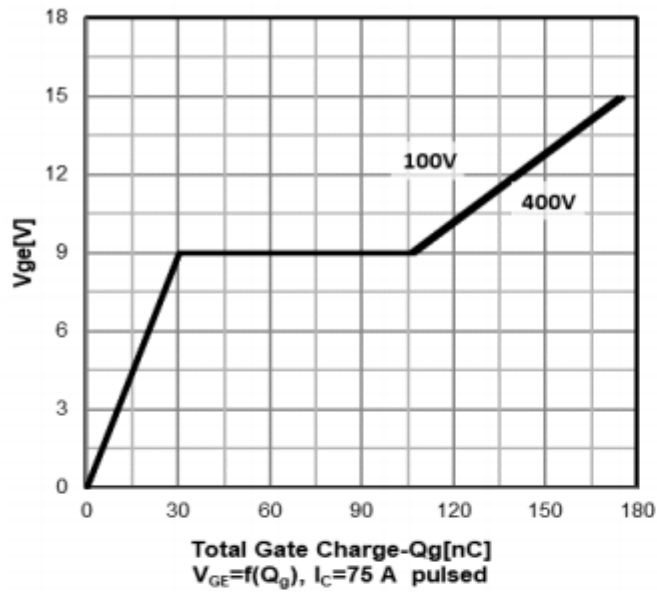
Typ. Collector-emitter saturation voltage as a function of junction temperature ( $V_{GE}=15\text{V}$ )



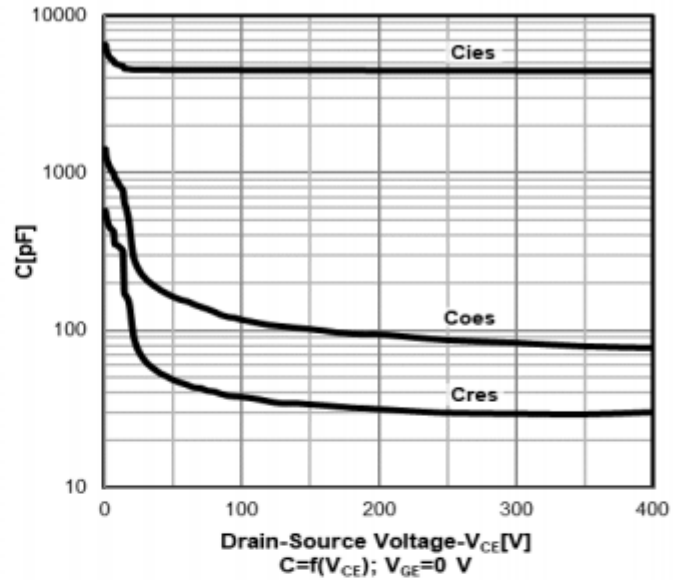
Normalized  $V_{GE(th)}$  vs. temperature



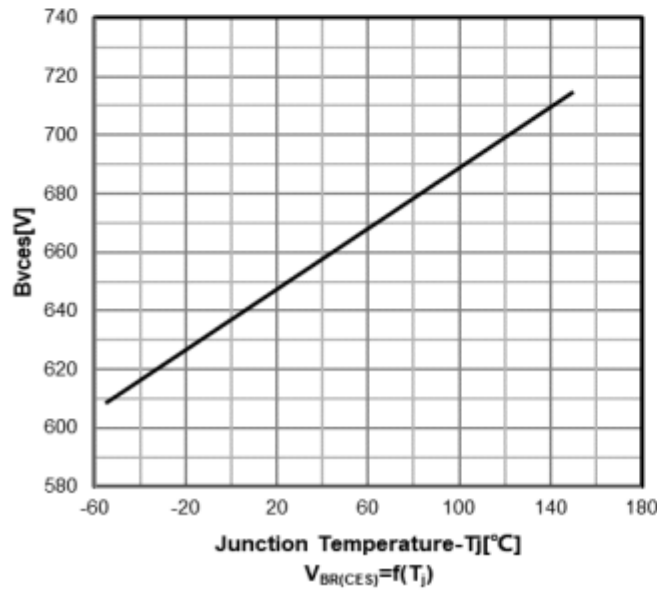
Gate charge characteristics



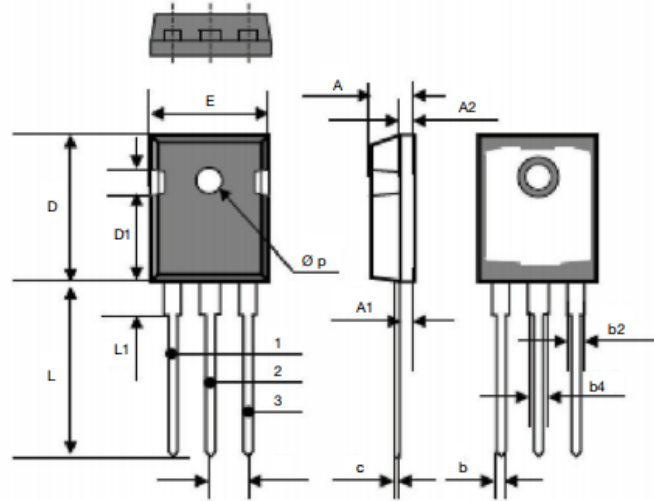
Capacitance characteristics



Collector-emitter breakdown voltage vs. temperature



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DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.70	5.31	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b2	1.65	2.41	0.065	0.095
b4	2.59	3.43	0.102	0.135
c	0.61 BSC		0.024 BSC	
D	20.80	21.46	0.819	0.845
D1	3.68	5.49	0.145	0.216
(e)	5.46 BSC		0.215 BSC	
E	15.49	16.26	0.610	0.640
L	19.81	20.32	0.780	0.800
L1	4.06	4.50	0.160	0.177
$\varnothing p$	3.51	3.66	0.138	0.144

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